

Website: www.feedpool.com

### Technical Data Sheet

## FeedBond® EP-3600-W2-3

# Insulated Thermally Conductive Adhesive

### **Description:**

**FeedBond**®**EP-3600-W2-3** is a modified epoxy type thermal conductive adhesive, apply for thermal management of electronic devices. It serves as an effective thermal interface material for heat sink devices where efficient cooling as well as long-term stability is required..

### **Application Package:**

Devices which need high thermal conductivity(Power Devices,RF ICs and LEDs)

### **Characteristics:**

- No yellowing due to heat and light
- High thermal conductivity
- Low drying during process
- Low bleed.

UNCURED PROPERTIES		TEST DESCRIPTION	TEST METHOD	
Density	1.9 g/cc	Pycnometer	FT-P001	
Appearance	White			
Viscosity @ 25°C	27000 cps	Brookfield DV-III/CP-51 @ 5rpm	FT-P006	
Thixotropic Index	3.8	Brookfield DV-III/CP-51	FT-P008	
@ 25°C	3.8	Visc. @ 0.5rpm/Visc. @ 5rpm		
Grind	<25μm	Grind meter	FT-P026	
Moisture Content	< 0.7 %	25°C/24hours	FT-P002	
Work Life @ 25°C	48hrs	25% increase in visc. @ 5rpm	FT-P024	
Shelf Life@ -40°C	0°C 6months 25% increase in visc. @ 5rpm		FT-P018	
CURE CONDITION		TEST DESCRIPTION	TEST METHOD	
Standard Cure Condition		90 minutes in oven @150°C		



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PHYSIOCHEMICAL PRO	PERTIES	TEST DESCRIPTION	TEST METHOD
Glass Transition Temperature (Tg) 154°C		DMA 3 Point Bending Mode	FT-M014
Hardness 94		Durometer Shore D	FT-P037
Coefficient of Thermal Expansion			
Below Tg(α1)	$40 \text{ ppm/}^{\circ}\text{C}$	TMA Expansion Mode	FT-M016
Above Tg(α2)	104ppm/°C		
Dynamic Tensile Modulus			
@25°C	7264MPa	Dynamic Mechanical Thermal	FT 1 (010)
@150°C	788MPa	Analysis using <1.6 mm thick specimen	FT-M019A
@250°C	443MPa		
Thermal conductivity	0.7 W/mK	Hot Disk	FT-P022
MECHANICAL PROPERTIES- POST CURE		TEST DESCRIPTION	TEST METHOD
Die Shear Strength @ 25°C	>120g/die	11mil × 11mil die on Ag Leadframe	FT-M012

### Instruction

### **Thawing**

Place the container to stand vertically for 60mins.**DO NOT** open the container before adhesive reaches ambient temperature to prevent the moisture condensation. Any moisture that collects on the thawed container should be removed prior to use. Adhesives that appear to have separated should not be used.

### **Storage**

Adhesive should be stored @ -40°C. The shelf life of the material is only valid when the material has been stored at the correct storage condition.

Storage Temp.	-42°C ~-35°C	-22°C ~-18°C	0°C~5°C	18°C~28°C
Shelf Life	6 months	6 months	3 months	2 days

### **Availability**

FeedBond<sup>®</sup> adhesives are packaged in syringes or pots per customer specification. For the details, please contact our Customer Service or sales department.